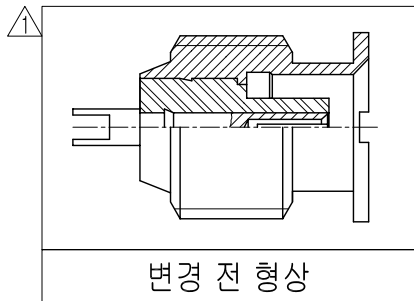
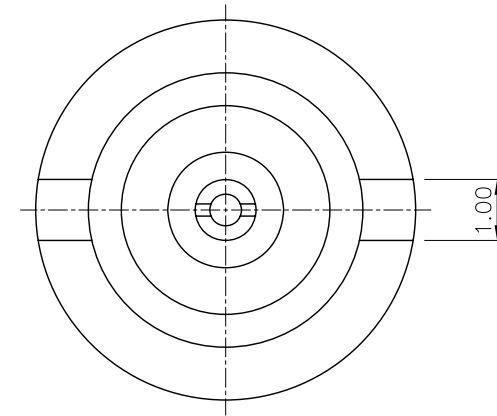
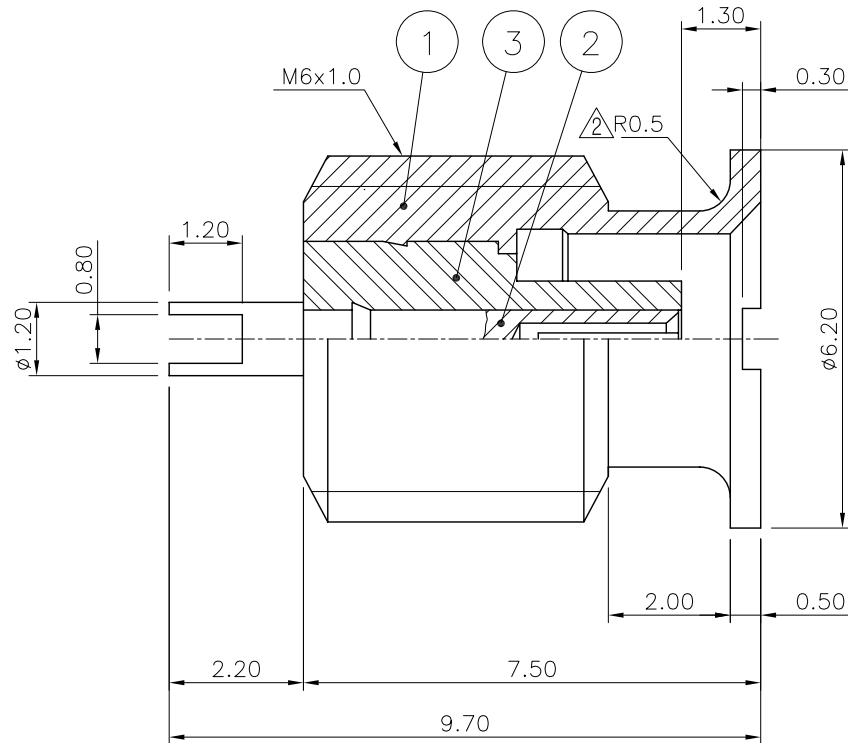


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.01.03.
1	[설번No.201401-0011]업체요청사항(BODY 형상 변경)	M.H.SONG	I.C.KIM	2014.01.20.
2	[설번No.201403-0001]업체요청사항(BODY 외경부 "R" 추가)	M.H.SONG	I.C.KIM	2014.03.06.



2 2 1	3	INSULATOR	1	TEFLON		DIN02119-N/1
	2	CONTACT	1	BeCu	Gold Plate	DCT02737-5/1
	1	BODY	1	MBsBD	Gold Plate	DBD03235-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
Decimal ±0.1	DATE 2014. 03. 06.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
Angle	APPROVED BY	I.C.KIM				
±1°	CHECKED BY	E.H.KIM		TITLE MCX50 SOLDER END JB (F/F)		
	DRAWN BY	M.H.SONG				
	SCALE 8/1	UNIT mm		A4	DWG NO. CN02916-7/1	
					REVISION 2	SHEET 1 of 1